

FEATURES

Single-supply operation: 3.3 V to 6.5 V
Rail-to-rail input, rail-to-rail output
High output current: 380 mA
Low supply current: 3.9 mA
Stable with 1 nF loads
Wide temperature range: -40°C to $+105^{\circ}\text{C}$
24-lead, Pb-free, TSSOP package

APPLICATIONS

LCD line inversion gamma references
Car navigation panels
Personal media player panels

GENERAL DESCRIPTION

The ADD8506 has 6-channel LCD gamma reference buffers designed to drive column driver gamma inputs in line inversion panels. Each buffer channel has an A/B input to select between two gamma voltage curves. These buffer channels drive the resistor ladders of LCD column drivers for gamma correction. The ADD8506 outputs have high slew rates and output drives that increase the stability of the reference ladder, resulting in optimal gray scale and visual performance.

The ADD8506 is specified over the -40°C to $+105^{\circ}\text{C}$ temperature range. It is available in a 24-lead thin shrink small outline (TSSOP), surface-mount, Pb-free package.

PIN CONFIGURATION DIAGRAM

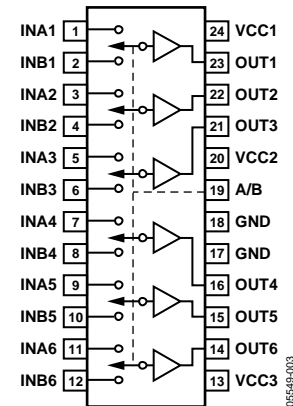


Figure 1.

Rev. 0

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TABLE OF CONTENTS

| | | | |
|----------------------------------|---|---|---|
| Features | 1 | Thermal Resistance | 4 |
| Applications..... | 1 | ESD Performance | 4 |
| General Description | 1 | ESD Caution..... | 4 |
| Pin Configuration Diagram | 1 | Typical Performance Characteristics | 5 |
| Revision History | 2 | Applications..... | 6 |
| Specifications..... | 3 | Outline Dimensions | 7 |
| Electrical Characteristics | 3 | Ordering Guide | 7 |
| Absolute Maximum Ratings..... | 4 | | |

REVISION HISTORY

9/05—Revision 0: Initial Version

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS

$V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$, unless otherwise noted. V_{IN} denotes buffer input voltage; I_{LOAD} denotes load current; R_L denotes load resistance; C_L denotes load capacitance.

Table 1.

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|------------------------------------|-----------|---|-------|------|-----|------------------|
| INPUT CHARACTERISTICS | | | | | | |
| Offset Voltage | V_{OS} | $0\text{ V} \leq V_{IN} \leq 5\text{ V}$ | | | 20 | mV |
| Input Common-Mode Voltage Range | V_{CM} | | 0 | | 5 | V |
| Input Bias Current | I_B | $V_{IN} = 2.5\text{ V}$ | | 2 | 50 | nA |
| Voltage Gain | A_{VO} | | 0.985 | | | V/V |
| OUTPUT CHARACTERISTICS | | | | | | |
| Output Voltage High | V_{OH} | $I_{LOAD} = +20\text{ mA}$ | 4.75 | | | V |
| Output Voltage Low | V_{OL} | $I_{LOAD} = -20\text{ mA}$ | | | 0.2 | V |
| Output Resistance | R_{OUT} | $-20\text{ mA} \leq I_{LOAD} \leq +20\text{ mA}$; $0.5\text{ V} \leq V_{IN} \leq 4.5\text{ V}$ | | 0.20 | | Ω |
| Output Short Circuit Current | I_{SC} | | 120 | 380 | | mA |
| POWER SUPPLY | | | | | | |
| Supply Current | I_{SY} | $V_{IN} = 2.5\text{ V}$ | | 3.9 | 5.1 | mA |
| Supply Voltage Range | V_{CC} | | 3.3 | | 6.5 | V |
| DYNAMIC PERFORMANCE | | | | | | |
| Slew Rate | SR | $C_L = 15\text{ pF}$ $R_L = 250\ \Omega$ | | 7.0 | | V/ μs |
| Settling Time | t_s | $C_L = 200\text{ pF}$, $R_L = 10\text{ k}\Omega$ | | 6.2 | | V/ μs |
| | | | | 2.5 | 6 | μs |
| LOGIC INPUT CHARACTERISTICS | | | | | | |
| Input Current Low | I_{IL} | $V_{IN} = 0.0\text{ V}$ | | | 100 | nA |
| Input Current High | I_{IH} | $V_{IN} = 5.0\text{ V}$ | | | 100 | nA |
| Input Voltage Low | V_{IL} | $V_{CC} = 5.0\text{ V}$, $-40^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$ | | | 0.8 | V |
| Input Voltage Low | V_{IL} | $V_{CC} = 3.3\text{ V}$, $-40^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$ | | | 0.7 | V |
| Input Voltage High | V_{IH} | $V_{CC} = 5.0\text{ V}$, $-40^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$ | 1.7 | | | V |
| Input Voltage High | V_{IH} | $V_{CC} = 3.3\text{ V}$, $-40^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$ | 1.4 | | | V |

ADD8506

ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter | Rating |
|--------------------------------------|-----------------|
| Supply Voltage | 7 V |
| Input Voltage | GND to V_{CC} |
| Storage Temperature Range | -65°C to +150°C |
| Junction Temperature Range | -65°C to +150°C |
| Lead Temperature (Soldering, 60 sec) | 300°C |

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

THERMAL RESISTANCE

Table 3. Thermal Package Characteristics

| Model | Package Type | θ_{JA}^1 | θ_{JC}^2 | Unit |
|-------------|-----------------------|-----------------|-----------------|------|
| ADD8506WRUZ | 24-Lead Pb-Free TSSOP | 128 | 45 | °C/W |

¹ θ_{JA} is specified for natural convection on a two-layer board.

² θ_{JC} is specified for natural convection on a two-layer board.

ESD PERFORMANCE

Table 4.

| Model | HBM ¹ | MM ² | FICDM ³ |
|-------------|------------------|-----------------|--------------------|
| ADD8506WRUZ | 3.5 kV | 200 V | 1.0 kV |

¹ Human body model.

² Machine model.

³ Field induced charge device model.



TYPICAL PERFORMANCE CHARACTERISTICS

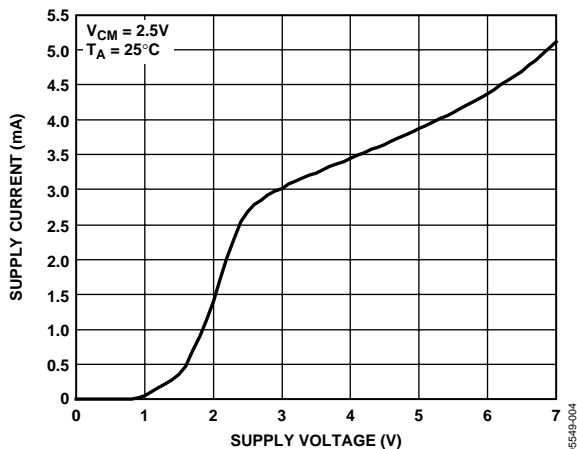


Figure 2. Supply Current vs. Supply Voltage

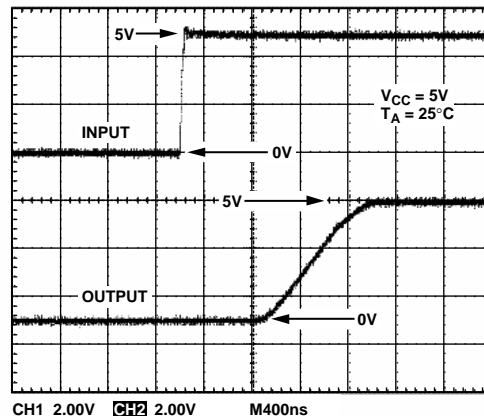


Figure 5. Transient Response—Rising

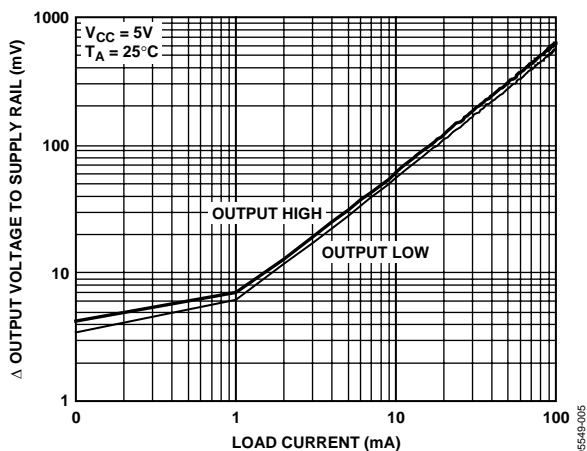


Figure 3. Δ Output Voltage to Supply Rail vs. Load Current

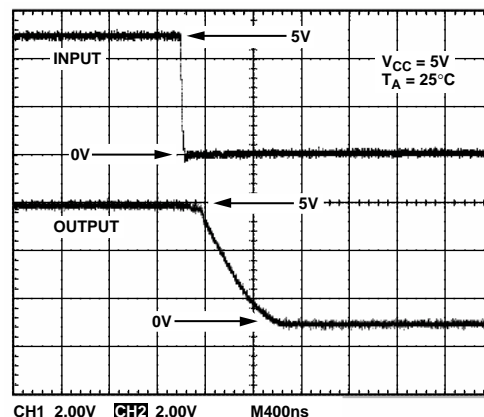


Figure 6. Transient Response—Falling

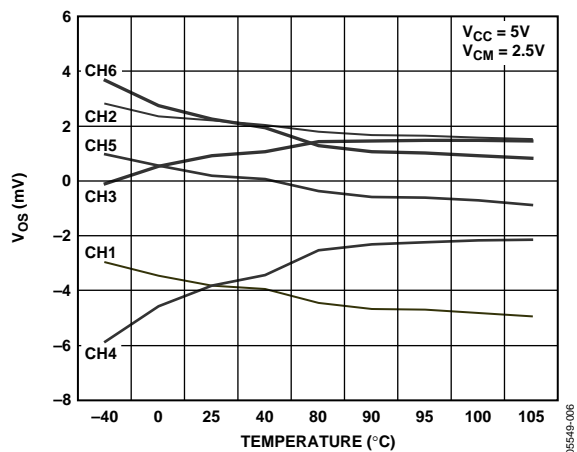


Figure 4. Offset Voltage vs. Temperature

APPLICATIONS

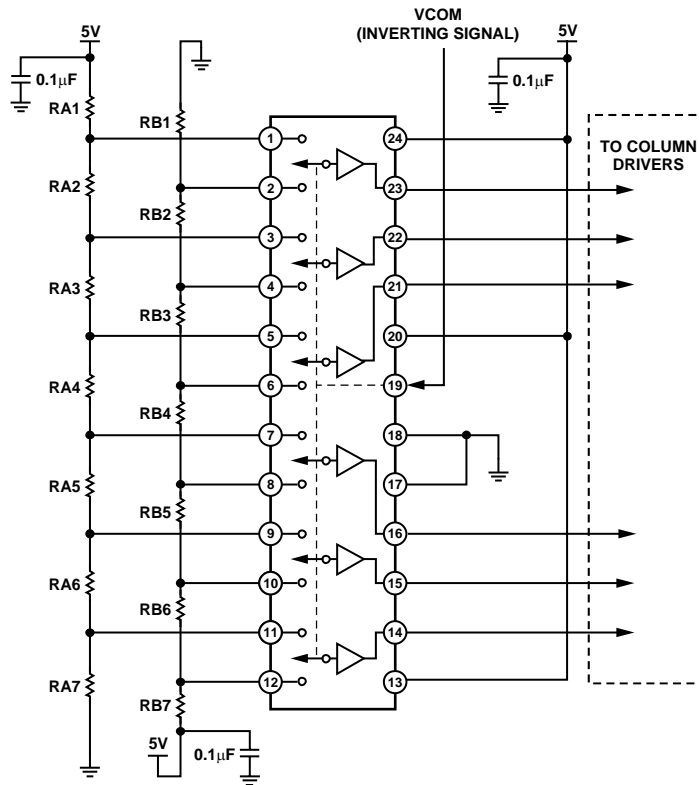
The ADD8506 has CMOS buffers with A/B inputs to select between two different reference voltages set up by an external resistor ladder. Input bias currents are orders of magnitude less than competitive parts. This allows the use of a very large resistor ladder to save supply current.

The buffer outputs are designed to drive resistive or capacitive loads. Therefore, to attain the best display performance, do not use resistors in series with these outputs. Outputs have high slew rates and 6 μ s settling times. Each output delivers a minimum of 120 mA, ensuring a fast response to varying loads.

Power supply pins on the ADD8506 have multiple ground (GND) and supply (V_{CC}) connections. Because of the high peak currents that these buffers deliver, it is recommended that all GND and V_{CC} pins be connected and suitably bypassed.

Table 5. MUX Function

| A/B Select | Input |
|------------|-------|
| Logic High | INAx |
| Logic Low | INBx |

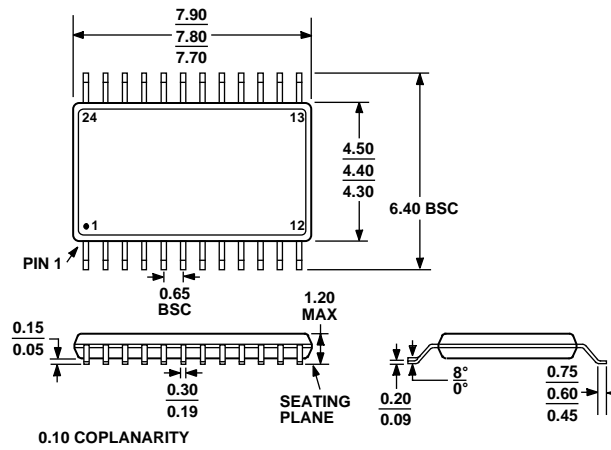


- NOTES**
1. RAx RESISTORS ARE USED TO SET POSITIVE INVERSION GAMMA VOLTAGES.
 2. RBx RESISTORS ARE USED TO SET NEGATIVE INVERSION GAMMA VOLTAGES.

05548-003

Figure 7. Typical Application

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-153-AD

Figure 8. 24-Lead Thin Shrink Small Outline Package [TSSOP] (RU-24)

Dimensions shown in millimeters

ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option | Ordering Quantity |
|--------------------------------|-------------------|---|----------------|-------------------|
| ADD8506WRUZ ¹ | -40°C to +105°C | 24-Lead Thin Shrink Small Outline Package [TSSOP], Tube | RU-24 | 96 |
| ADD8506WRUZ-REEL7 ¹ | -40°C to +105°C | 24-Lead Thin Shrink Small Outline Package [TSSOP], 7" Reel | RU-24 | 1,000 |
| ADD8506WRUZ-REEL ¹ | -40°C to +105°C | 24-Lead Thin Shrink Small Outline Package [TSSOP], 13" Reel | RU-24 | 2,500 |

¹ Z = Pb-free part.

ADD8506

NOTES